ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	PC. Bannockt	ourn. Illinois. A	ll rights reserved un tions.	nder both	This docume level parts, t	ent is a declaratio the declaration en	n of the substanc compasses all lo	es within the manufactur wer level materials for w	er listed ite hich the ma	em. Note: if unufacturer	the item is an as has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard For http://www.ipc.org/IPC-175x Dis								g Informatio	on			
Supplier Information													
Company name* Compan			ompany unique ID			Unique ID Authority				Response Date*			
onsemi										2023-06-08			
Contact Name Title - Contact			.t		Phone - Contact*			Email - Contact*					
Product-Env-Stewards Product Envi			nviro Compliance		NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Represe			resentative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards Product Env			t Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	Manufacturing Site	V	veight*	UOM	Unit Type	
	AMIS30	AMIS30600LINI1RG LIN Transcei		'er		2023-06-08		PHG		1.78	mg	Each	
Aanufacturing Proccess Informa	tion								Ļ				
Terminal Plating / Grid Array M	Terminal Plating / Grid Array Material Terminal Base /		Alloy J-	STD-020 MSL	Rating	Peak Proces	s Body Tempera	ture Max Time at Peak	Temperatu	re Numbe	er of Reflow Cyc	cles	
Matte Tin (Sn) - annealed CU Alloy			2			260	С	30	second	s 3			
omments													
TTENTION: MSL 2 Rated item require	es Dry Pack (a	after electrical	test)										
or more information regarding material	composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.89	mg	Supplier	Silicon (Si)	7440-21-3		3.89	mg
Die Attach	1.25	mg		Epoxy resin	proprietary data		0.0312	mg
			Supplier	Silver (Ag)	7440-22-4		1.0563	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0312	mg
			Supplier	Inorganic filler	Proprietary Data		0.0312	mg
			Supplier	Dicyandiamine	461-58-5		0.0062	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0937	mg
Lead Frame	29.12	mg	Supplier	Zinc (Zn)	7440-66-6		0.0291	mg
			Supplier	Iron (Fe)	7439-89-6		0.6698	mg
			Supplier	Copper (Cu)	7440-50-8		28.392	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0291	mg
Mold Compound-Black	46.29	mg		Epoxy resin	proprietary data		2.3145	mg
			Supplier	Phenolic Resin	Proprietary Data		2.3145	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.9258	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2315	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		40.5037	mg
Plating	0.96	mg	Supplier	Tin (Sn)	7440-31-5		0.96	mg
Wire Bond - Au	0.27	mg	Supplier	Gold (Au)	7440-57-5		0.27	mg